IMP

INTRODUCTION



This new concept is protected worldwide by a patent and second sources are available through licences.

Tiny Connector

• High density.

IMP connector needs only 22.2 mm² on board (5.7x3.9).

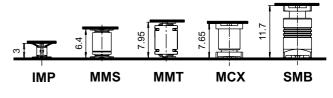
World's lightest connector.

IMP board to board link weight is only 0.02 g.

World's lowest profile for a board to board adapter.

IMP height is 3 mm!

Others heights possible. Please contact us.



Scale: 1/1

Industry approval

Design adapted to automated pick and placement machines

The footprint of the **IMP** connector allows video-positioning using the component's shadow to facilitate its placement (page 10).

The **IMP** connector is fully compatible with automated pick and place machines.

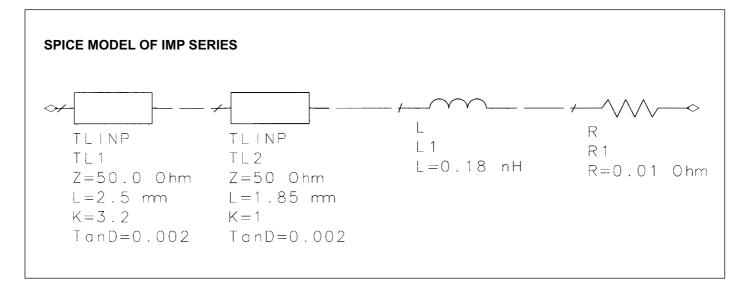
Packaging

The **IMP** connector is packaged in reels of antistatic plastic embossed tape (page 8) containing either 600 or 2500 **IMP** connectors.

The cavity geometry is designed for a perfect positioning of the component.

Many applications

- Wide frequency range up to 6 Ghz.
- Custom height and custom diameter on board are possible upon request.









DC - 6 GHz

GENERAL

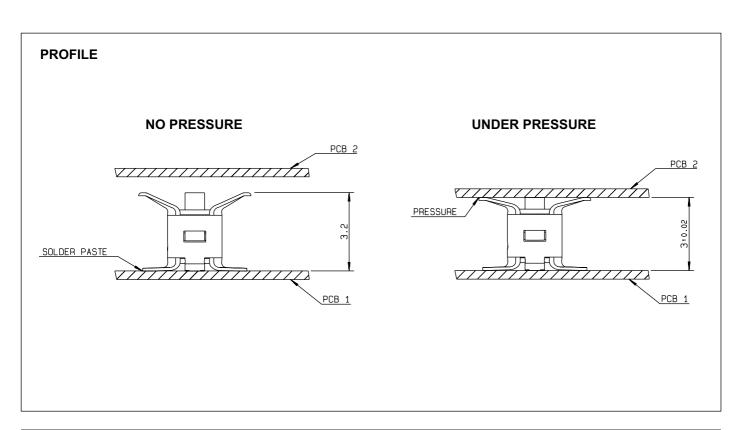
- Ultra low profile coaxial connectors
- Surface mount connectors
- Press-on electrical contact
- Fully compatible with automated pick and place machines
- High RF performance
- Radiall patent

APPLICATIONS

Board to board applications

MARKETS

- WLAN
- Mobile phone
- Terminals
- Automotive





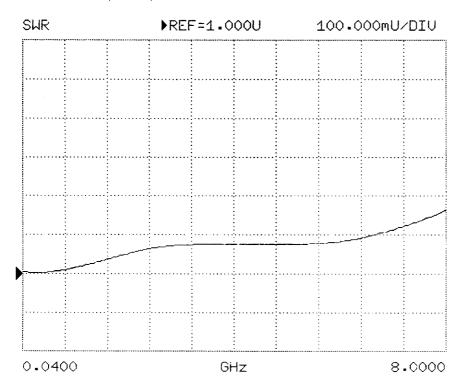


CHARACTERISTICS



	TEST STANDARD	RESULTS
ECTRICAL CHARACTERISTICS		
Impedance		50Ω
Frequency range		DC - 6 GHz
V.S.W.R.	CECC 22 000	1.10+0.03 F (F in GHz)
Insertion loss (dB)	CECC 22 000	0.2 √F (F in GHz)
Insulation resistance	CECC 22 000	3000 MΩ min
Contact resistance		
center contact	CECC 22 000	15 m Ω
outer contact	CECC 22 000	$5~\text{m}\Omega$
Working voltage in VRMS	CECC 22 000	100
Dielectric withstanding voltage in VRMS	CECC 22 000	350
Weight (g)	CECC 22 000	0.02
ECHANICAL CHARACTERISTICS Durability	CECC 22 000	20 matings
<u> </u>	•	
NVIRONMENTAL CHARACTERISTICS		
Temperature range	CECC 22 000	-40°C ,+90°C
ATERIALS		
Bodies		Beryllium copper
Center contact		Beryllium copper
Outer contact		Beryllium copper
Insulator		Polyether ethercetone 30% GF
		·
ATINGS		
Bodies		Gold
Center contact		Gold
Outer contact		Gold

Power: at sea level, at 20°C, 3 Ghz max: 20 W



Frequency	Typical VSWR
1 GHz	1.01
2 GHz	1.04
3 GHz	1.06
4 GHz	1.08
5 GHz	1.08
6 GHz	1.08

